

APA750-FGG676

a Quote

APA750-FGG676 Information

	Part Number	APA750-FGG676	
www.bussep com	Manufacturer	Microsemi Corporation	
	Category	Integrated Circuits (ICs) Embedded - FPGAs (Field Programmable Gate Array)	
	Description	IC FPGA 454 I/O 676FBGA	
	Package	676-BGA	
For Reference Only		For the pricing/inventory/lead time, please contact us	
		Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



APA750-FGG676 Specifications

Manufacturer Part Number	APA750-FGG676
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	676-BGA
Series	ProASICPLUS
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	147456
Number of I/O	454
Number of Gates	750000
Voltage - Supply	2.3 V ~ 2.7 V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
	Report errors?

APA750-FGG676 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE ELARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

APA750-FGG676 Payment Methods



APA750-FGG676 Shipping Methods



If you have any question about APA750-FGG676, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com